
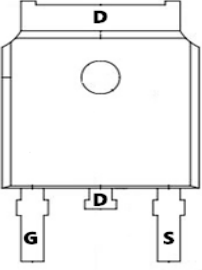


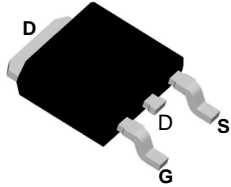
**TMN30100D**

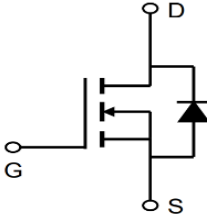
**N-Channel Enhancement Mosfet**

|  |   |
|--|---|
| <p><b>General Description</b></p> <ul style="list-style-type: none"> <li>• Low <math>R_{DS(ON)}</math></li> <li>• RoHS and Halogen-Free Compliant</li> </ul> <p><b>Applications</b></p> <ul style="list-style-type: none"> <li>• Load switch</li> <li>• PWM</li> </ul> | <p><b>General Features</b></p> <p><math>V_{DS} = 30V</math> <math>I_D = 100A</math><br/> <math>R_{DS(ON)} = 3.5m\Omega (typ) @ V_{GS} = 10V</math></p> <p>100% UIS Tested<br/>             100% <math>R_g</math> Tested</p>  |
|--|---|



**D:TO-252-3**





Marking: 100N03

**Absolute Maximum Ratings** ( $T_A = 25^\circ C$  unless otherwise noted)

| Symbol                | Parameter                 | Rating              | Unit       |
|-----------------------|---------------------------|---------------------|------------|
| <b>Common Ratings</b> |                           |                     |            |
| $V_{DSS}$             | Drain-Source Voltage      | 30                  | V          |
| $V_{GSS}$             | Gate-Source Voltage       | $\pm 20$            |            |
| $I_D$                 | Continuous Drain Current  | $T_C = 25^\circ C$  | 100        |
|                       |                           | $T_C = 100^\circ C$ | 39         |
| $I_{DM}$              | Pulsed Drain Current      | $T_C = 25^\circ C$  | 160        |
| $P_D$                 | Power Dissipation         | $T_A = 25^\circ C$  | 3.6        |
| $P_D$                 | Power Dissipation         | $T_C = 25^\circ C$  | 52         |
| $T_{STG}, T_j$        | Storage Temperature Range | -55 to 150          | $^\circ C$ |
| $I_D$                 | Continuous Drain Current  | $T_A = 25^\circ C$  | 18         |
|                       |                           | $T_A = 70^\circ C$  | 14         |

**Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress rating only and functional device operation is not implied.**



**TMN30100D**

**N-Channel Enhancement Mosfet**

**Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$  unless otherwise specified)

| Symbol   | Parameter                        | Test Conditions  | Min. | Typ. | Max.      | Unit       |
|--|----------------------------------|--|------|------|-----------|------------|
| <b>Static Characteristics</b>                  |                                  |  |      |      |           |            |
| $BV_{DSS}$                                     | Drain-Source Breakdown Voltage   | $V_{GS}=0V, I_{DS}=250\mu A$                                       | 30   | -    | -         | V          |
| $I_{DSS}$                                      | Zero Gate Voltage Drain Current  | $V_{DS}=24V, V_{GS}=0V$<br>$T_J=85^{\circ}\text{C}$                | -    | -    | 1         | $\mu A$    |
|  |                                  |  | -    | -    | 30        |            |
| $V_{GS(th)}$                                   | Gate Threshold Voltage           | $V_{DS}=V_{GS}, I_{DS}=250\mu A$                                   | 1    | -    | 2.5       | V          |
| $I_{GSS}$                                      | Gate Leakage Current             | $V_{GS}=\pm 20V, V_{DS}=0V$  | -    | -    | $\pm 100$ | nA         |
| $R_{DS(ON)}$                                   | Drain-Source On-state Resistance | $V_{GS}=10V, I_{DS}=20A$   | -    | 3.5  | 5.5       | m $\Omega$ |
|  |                                  | $V_{GS}=4.5V, I_{DS}=15A$  | -    | 5.5  | 6.8       |            |
| <b>Body Diode Characteristics</b>              |                                  |  |      |      |           |            |
| $V_{SD}$                                       | Diode Forward Voltage            | $I_{SD}=40A, V_{GS}=0V$  | -    | 0.7  | 1.3       | V          |
| <b>Dynamic Characteristics<sup>e</sup></b>     |                                  |  |      |      |           |            |
| $C_{iss}$                                      | Input Capacitance                | $V_{GS}=0V, V_{DS}=10V,$<br>Frequency=1.0MHz                       | -    | 1356 | -         | pF         |
| $C_{oss}$                                      | Output Capacitance               |  | -    | 55   | -         |            |
| $C_{rss}$                                      | Reverse transfer capacitance     |  | -    | 45   | -         |            |
| $t_{d(ON)}$                                    | Turn-on delay Time               | $V_{GS}=10V, V_{DS}=15V$<br>$R_G=1.8\Omega, I_D=20A, R_L=30\Omega$ | -    | 8    | -         | nS         |
| $t_r$  | Turn-on rise Time                |  | -    | 9    | -         |            |
| $t_{d(OFF)}$                                   | Turn-off delay Time              |  | -    | 32   | -         |            |
| $t_f$  | Turn-off rise Time               |  | -    | 6    | -         |            |
| <b>Gate Charge Characteristics<sup>e</sup></b> |                                  |  |      |      |           |            |
| $Q_g$  | Total Gate Charge                | $V_{DS}=15V, V_{GS}=10V, I_{DS}=20A$                               | -    | 23   | -         |            |
| $Q_{gs}$                                       | Gate-Source Charge               |  | -    | 5    | -         |            |
| $Q_{gd}$                                       | Gate-Drain Charge                |  | -    | 3    | -         |            |

Note: 1. Pulse test: pulse width $\leq 300\mu S$ , duty cycle $\leq 2\%$

2. Static parameters are based on package level with recommended wire bonding

### Typical Performance Characteristics

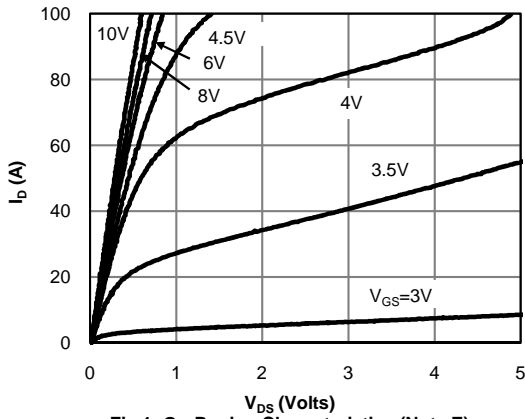


Fig 1: On-Region Characteristics (Note E)

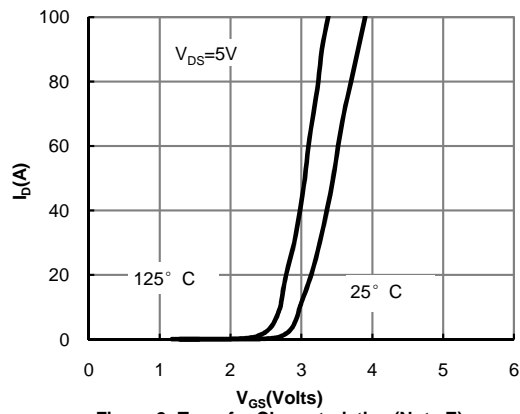


Figure 2: Transfer Characteristics (Note E)

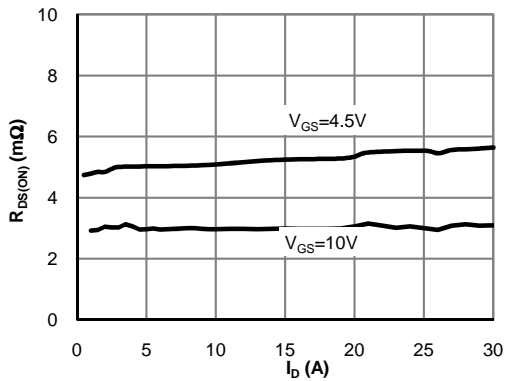


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

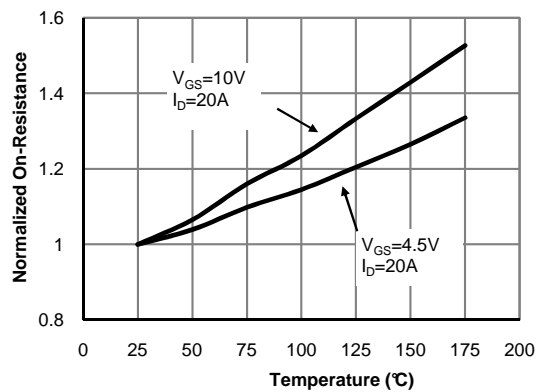


Figure 4: On-Resistance vs. Junction Temperature (Note E)

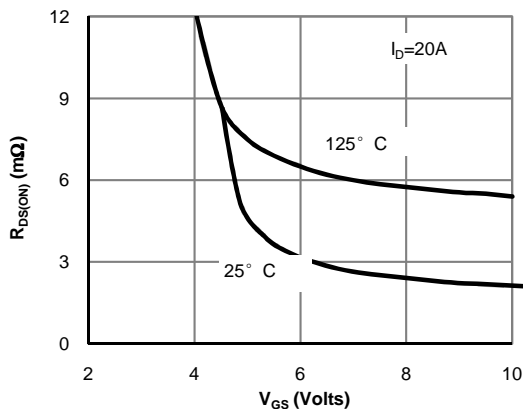


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

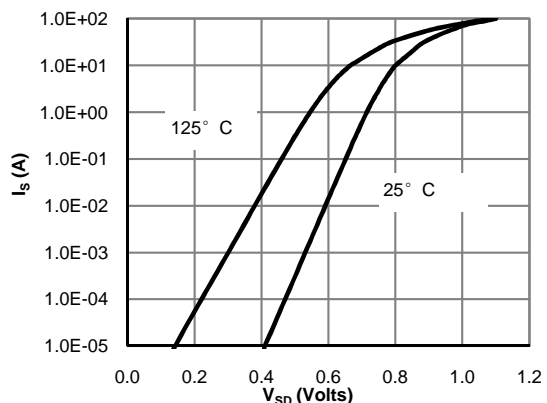


Figure 6: Body-Diode Characteristics (Note E)

**TMN30100D**

**N-Channel Enhancement Mosfet**

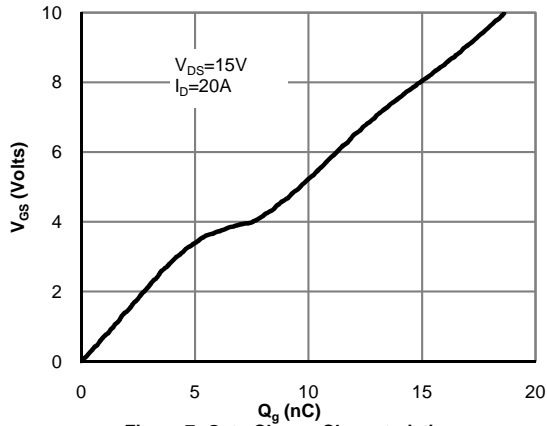


Figure 7: Gate-Charge Characteristics

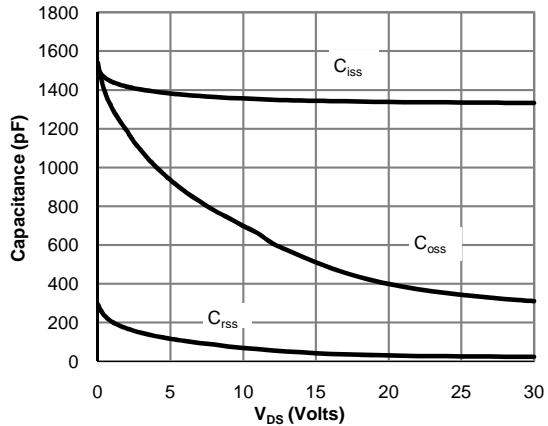


Figure 8: Capacitance Characteristics

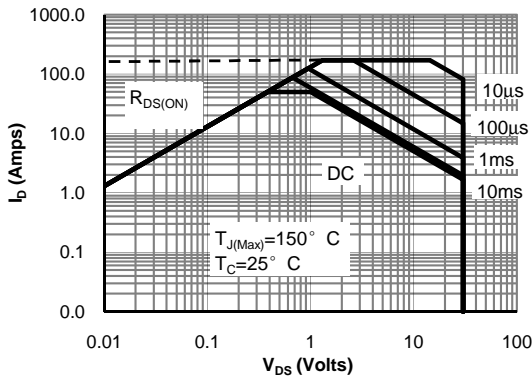


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

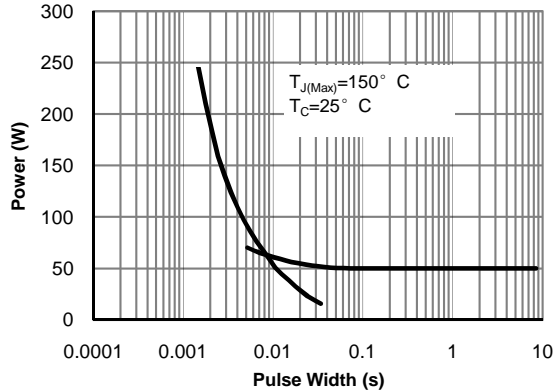


Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)

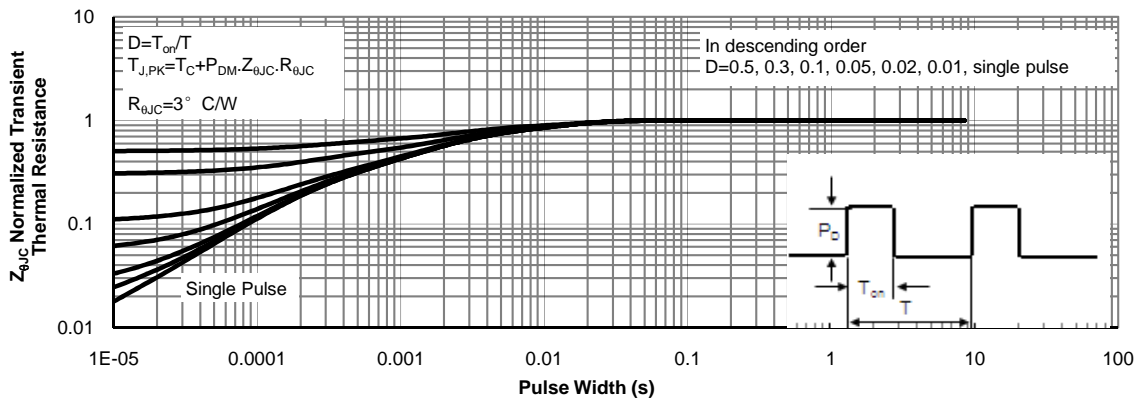
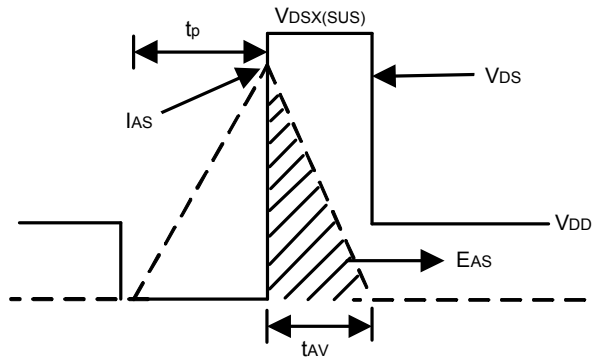
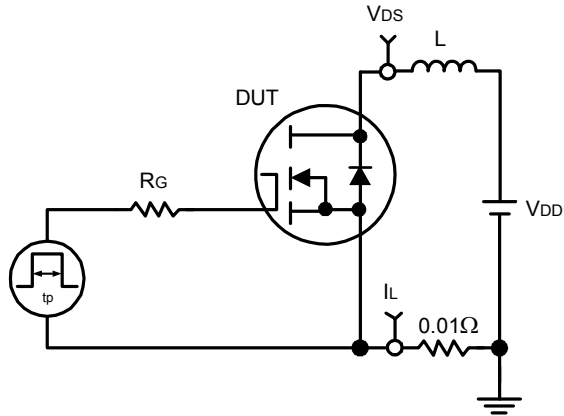
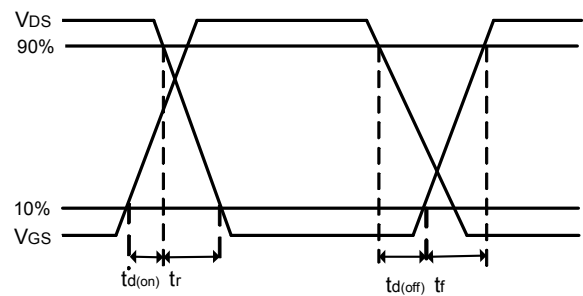
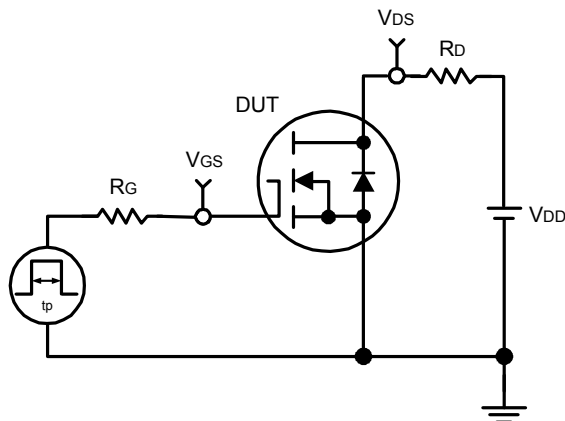


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

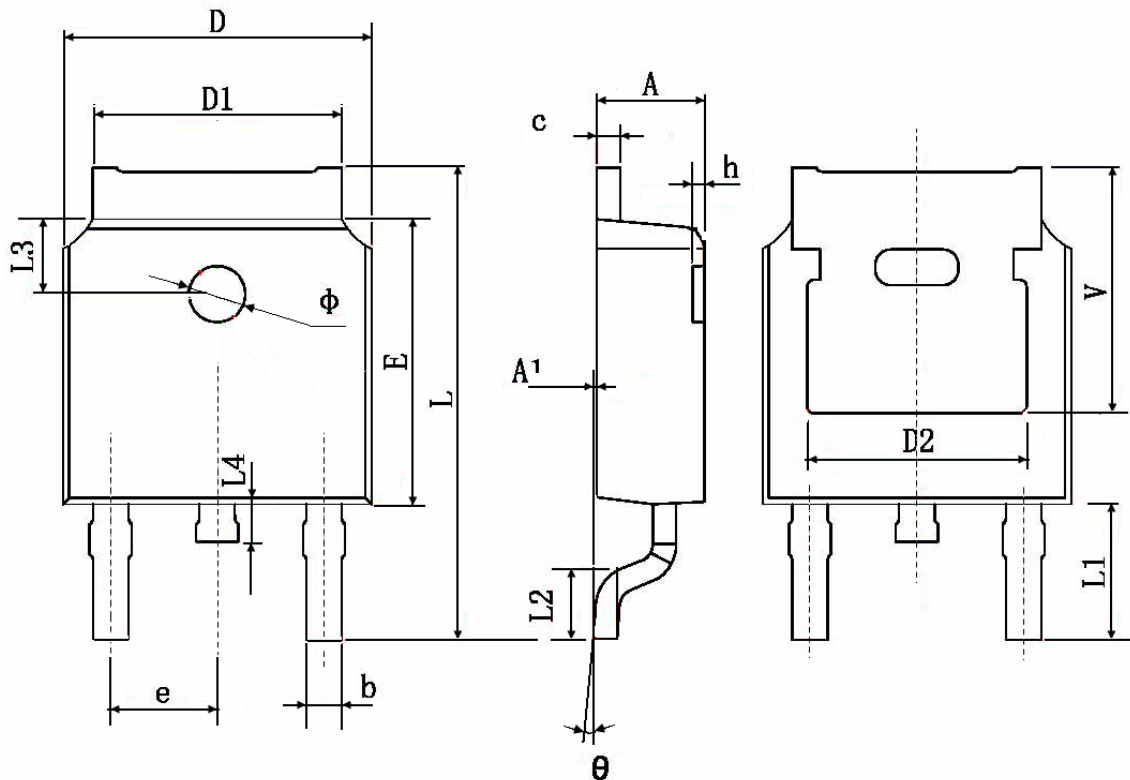
### Avalanche Test Circuit and Waveforms



### Switching Time Test Circuit and Waveforms



## Package Information: TO-252-3L



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |

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